| Docket No.:   |  |   |
|---|--|---|
| DECLARATIO  | ON AND POWER C   | OF ATTORNEY   |
| As a below named inventor, I hereby dec   | lare that:   |   |
| My residence, post office and citizenship   | are as stated below next to my 1   | name,   |
| I believe I am the original, first and sole inventor (if plural names are listed below invention entitled <u>WINDOW TYPE AIR COU</u>  | <ul> <li>w) of the subject matter claime</li> </ul>  | listed below) or an original, first and joint and for which a patent is sought on the, the specification of which   |
| [x] is attached hereto [] was filed   |  |   |
| amended on  |  |   |
| I hereby state that I have reviewed and uclaims, as amended by any amendment re   | inderstand the contents of the a   | above identified specification, including the   |
| I acknowledge the duty to disclose information with Title 37, Code of Federal Regulation  | nation which is known to me tos, Section 1.56(a).  | o be material to patentability in accordance  |
| I hereby claim foreign priority benefits ur<br>or inventor's certificate, or 365(a) of any I<br>than the United States of America, listed<br>application for patent or inventor's certifithat of the application on which priority is | PCT international application who<br>below and have also identified b<br>cate, or of any PCT internations                      | (b) of any foreign application(s) for patent<br>hich designated at least one country other<br>below, by checking the box, any foreign<br>al application having a filing date before   |
| Prior Foreign Application(s): Number  | <u>Country</u>   | Foreign Filing Date<br><u>Month/Day/Year</u>  |
| 74403/2003  | Korea  | 10/23/2003  |
|   |  |   |
|   |  |   |
| I hereby claim the benefit under 35 U.S.C   | 119(e) of any United States pr   | ovisional application(s) listed below.  |
| Application Number(s):  | Filing Date (Month/Day/Year)   |   |
| international application designating the I each of the claims of this application is not the manner provided by the first paragraph  | United States of America, listed tot disclosed in the prior United to of 35 U.S.C. 112, I acknowle 37 CFR 1.56 which became av | tes application(s), or 365(c) of any PCT below and, insofar as the subject matter of d States or PCT international application in edge the duty to disclose information which railable between the filing date of the prior cation. |
| Prior U. S. Application or PCT Parent Number Filing   | g Date (Month/Day/Year)  | Parent Patent Number (if applicable)  |
| PCT/KR2004/002370 Se  | eptember 16, 2004  | · = • • •   |
|   |  |   |
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s) associated with Customer Number 34610 with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. <u>Direct all correspondence to Customer Number 34610</u>.

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